



COMBINED DECLARATION, POWER OF ATTORNEY
PATENT APPLICATION AND PETITION

In re application of: Abdul Q. Khan and George K. Wai

Serial No.: 09/915,750

Examiner: unknown

Filed: 07/26/2001

Docket No.: 5637I

Title: PROCESS FOR DIGESTING WOODCHIPS AND DIGESTER ADDITIVES

As a below named inventor, I hereby declare the following:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter (if only one inventor) **an original, first and joint inventor** (if more than one inventor) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: PROCESS FOR DIGESTING WOODCHIPS AND DIGESTER ADDITIVES

the specification of which

☐ is attached hereto.

☒ was filed on 07/26/2001 as Application Serial No. 09/915,750 or Express No. _____, and was amended on _____ (if applicable).

☐ was described and claimed in PCT International Application No. _____, filed on _____, and as amended under PCT Article 19 on _____ (if any).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

I claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's

certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

App. No.	Country	Filing Date	Priority Claimed Yes ____ No ____
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I hereby claim the benefit under Title 35, United States Code §119(e) of any United States provisional application(s) listed below:

App. No.	Filing Date
<u>60/221,663</u>	<u>07/27/2000</u>

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(App.No.)	(Filing Date)	(Status)
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I hereby appoint the following attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

David L Hedden, 29388
Vernon F. Venne, 27014
Martin Connaughton, 33857
Burton A. Amernick, 24852

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David L. Hedden at 614-790-4265.

Address all correspondence to

David L. Hedden
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P.O. Box 2219
Columbus, Ohio 43216.


Wherefore I pray that Letters patents be granted to me for the invention or discovery and claimed in the foregoing specification and claims, and I hereby subscribe my name to the foregoing specification and claims, declaration, power of attorney, and this petition.

I hereby declare that all statements made herein of my knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FIRST INVENTOR

Full name of sole or first inventor: Abdul Q. Khan

Inventor's signature



Date

10/22/01

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Citizenship:

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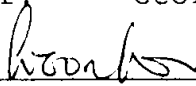
Post Office Address:

(Same as residence)

SECOND INVENTOR

Full name of second joint inventor: George K. Wai

Inventor's signature



Date 10.22-01

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